
2SK2726

Silicon N Channel MOS FET
High Speed Power Switching

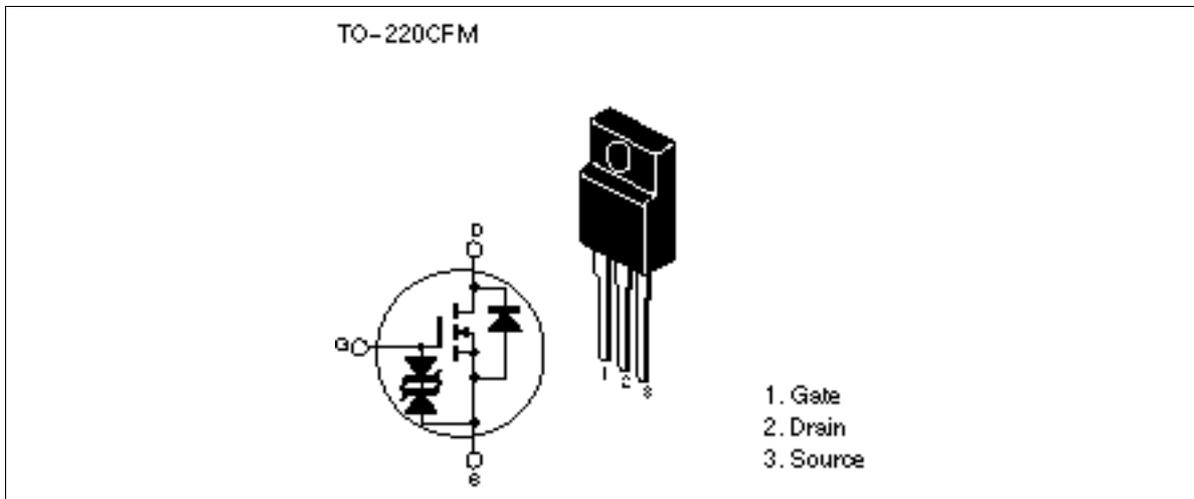
HITACHI

ADE-208-453 B
3rd. Edition

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Avalanche ratings

Outline



2SK2726

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	500	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	7	A
Drain peak current	I _{D(pulse)} * ¹	28	A
Body to drain diode reverse drain current	I _{DR}	7	A
Avalanche current	I _{AP} * ³	7	A
Avalanche energy	E _{AR} * ³	2.7	mJ
Channel dissipation	P _{ch} * ²	30	W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Notes: 1. PW ≤ 10μs, duty cycle ≤ 1 %

2. Value at T_c = 25°C

3. Value at T_{ch} = 25°C, R_g = 50Ω, L = 100 μH

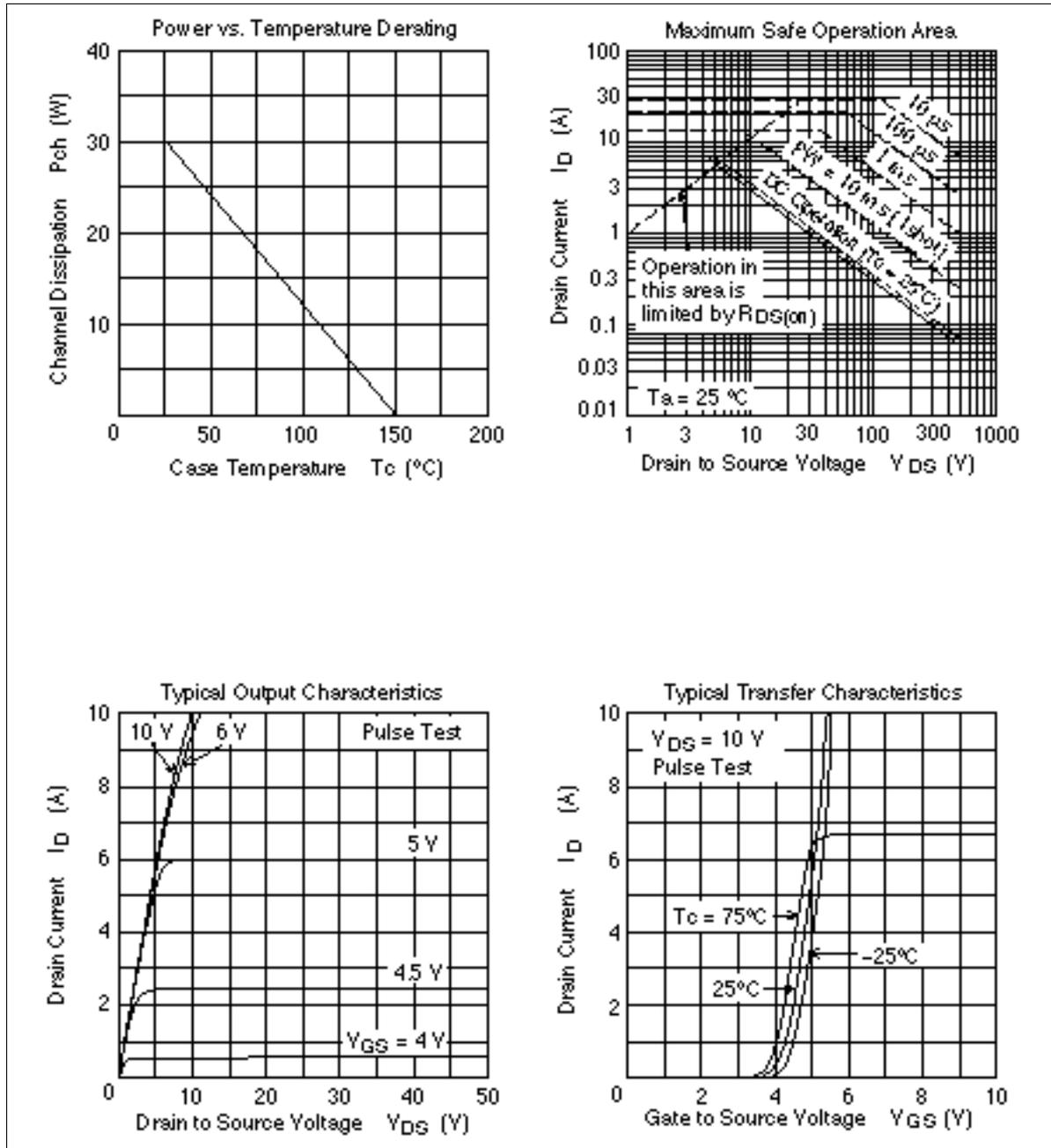
Electrical Characteristics (Ta = 25°C)

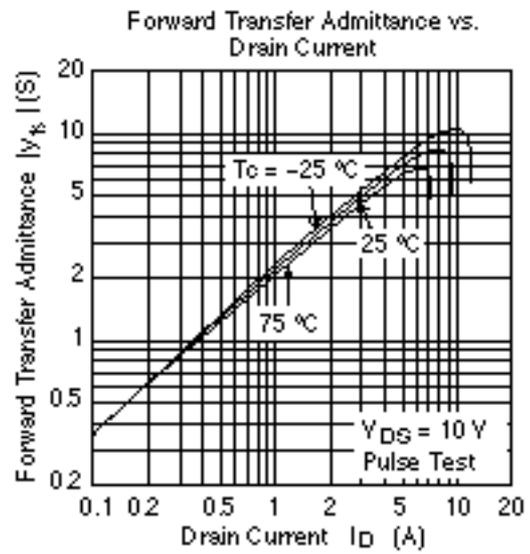
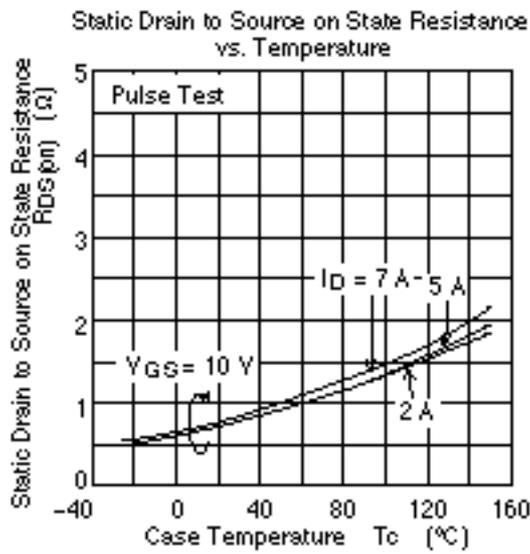
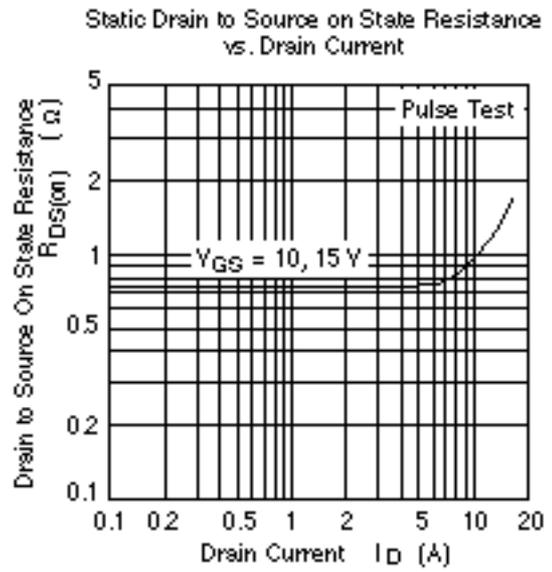
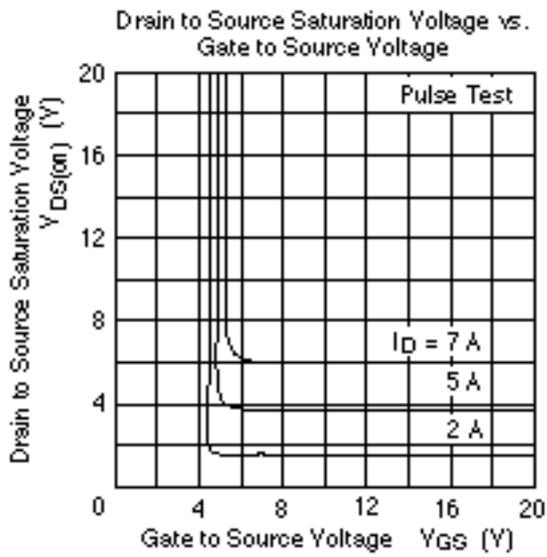
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	500	—	—	V	$I_D = 10\text{mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 30	—	—	V	$I_G = \pm 100\mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 10	μA	$V_{GS} = \pm 25\text{V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 500\text{V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.5	—	3.5	V	$I_D = 1\text{mA}$, $V_{DS} = 10\text{V}^{*1}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.75	0.95	Ω	$I_D = 4\text{A}$, $V_{GS} = 10\text{V}^{*1}$
Forward transfer admittance	$ y_{fs} $	3.5	6.0	—	S	$I_D = 4\text{A}$, $V_{DS} = 10\text{V}^{*1}$
Input capacitance	C_{iss}	—	1100	—	pF	$V_{DS} = 10\text{V}$
Output capacitance	C_{oss}	—	330	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	65	—	pF	$f = 1\text{MHz}$
Total gate charge	Q_g	—	21	—	nc	$V_{DD} = 400\text{V}$
Gate to source charge	Q_{gs}	—	5	—	nc	$V_{GS} = 10\text{V}$
Gate to drain charge	Q_{gd}	—	8	—	nc	$I_D = 7\text{A}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$V_{GS} = 10\text{V}$, $I_D = 4\text{A}$
Rise time	t_r	—	65	—	ns	$R_L = 7.5\Omega$
Turn-off delay time	$t_{d(off)}$	—	60	—	ns	
Fall time	t_f	—	40	—	ns	
Body to drain diode forward voltage	V_{DF}	—	0.95	—	V	$I_D = 7\text{A}$, $V_{GS} = 0$
Body to drain diode reverse recovery time	t_{rr}	—	260	—	ns	$I_F = 7\text{A}$, $V_{GS} = 0$ $di_F/dt = 100\text{A}/\mu\text{s}$

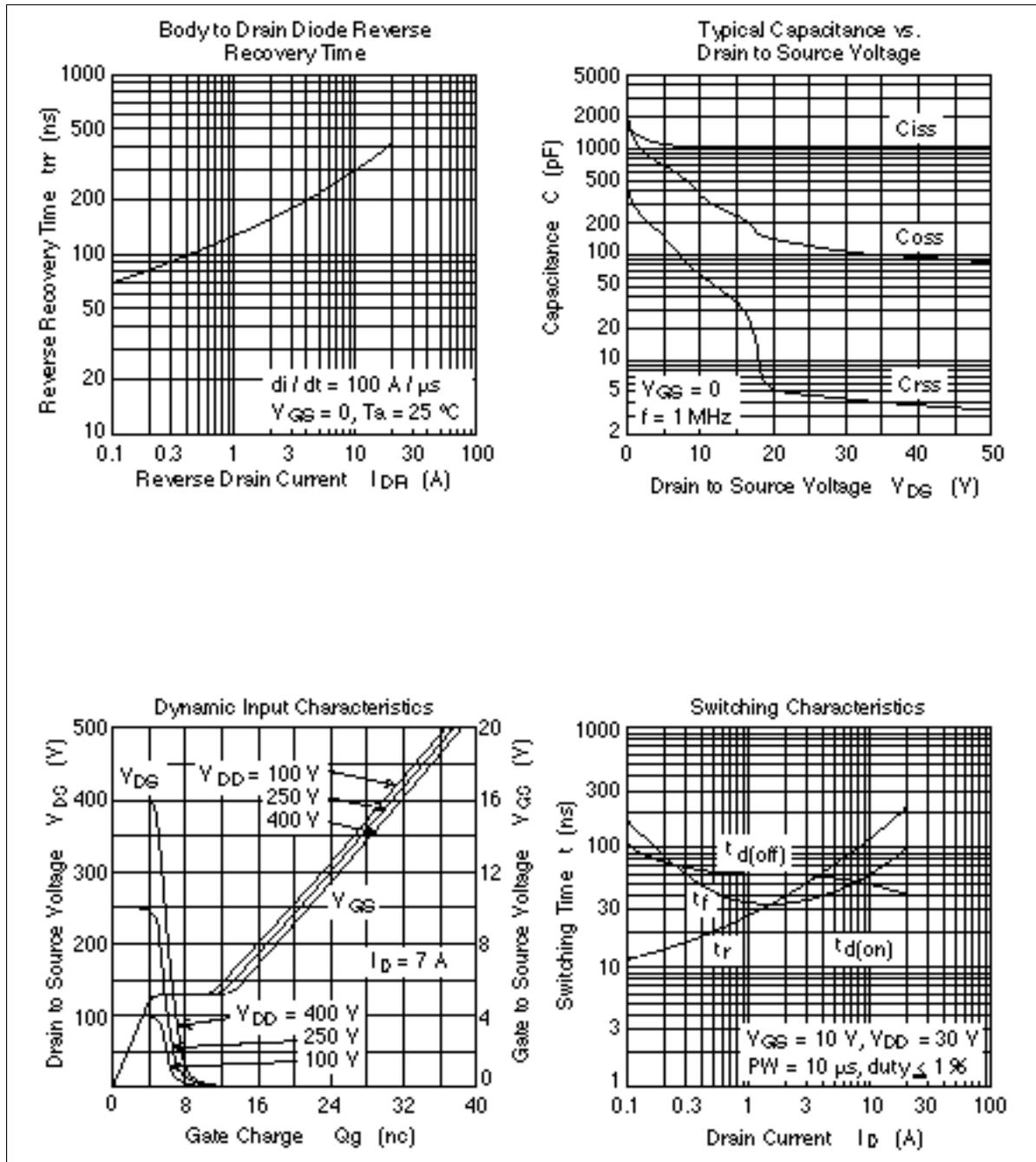
Note: 1. Pulse test

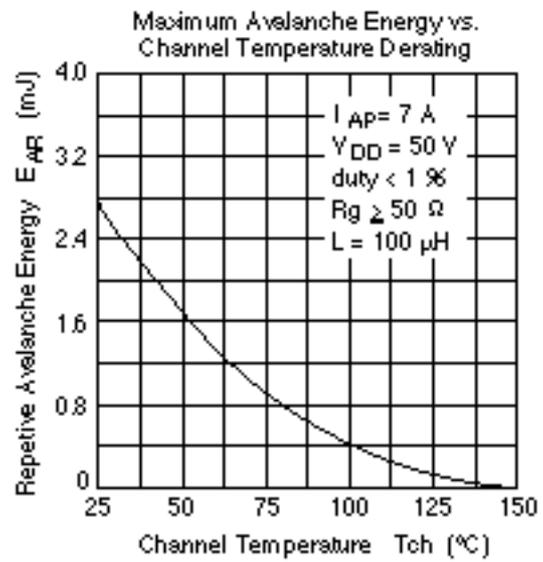
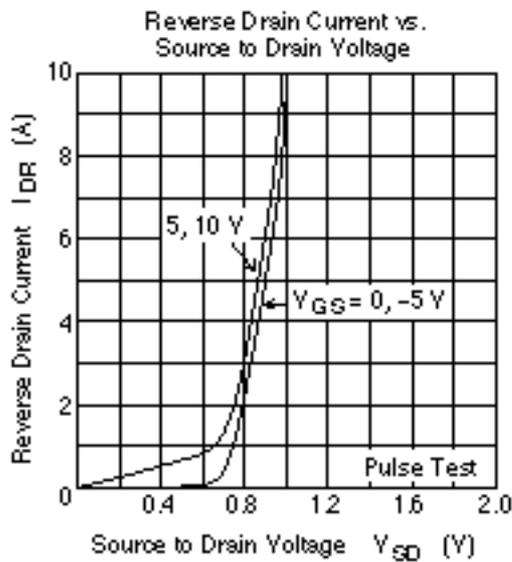
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Main Characteristics

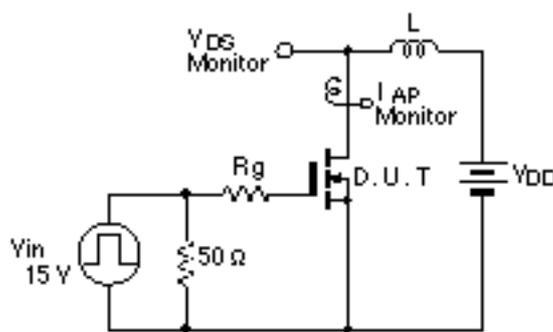






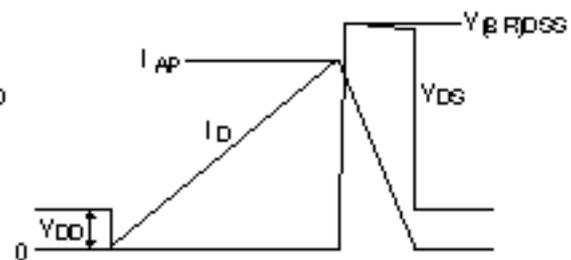


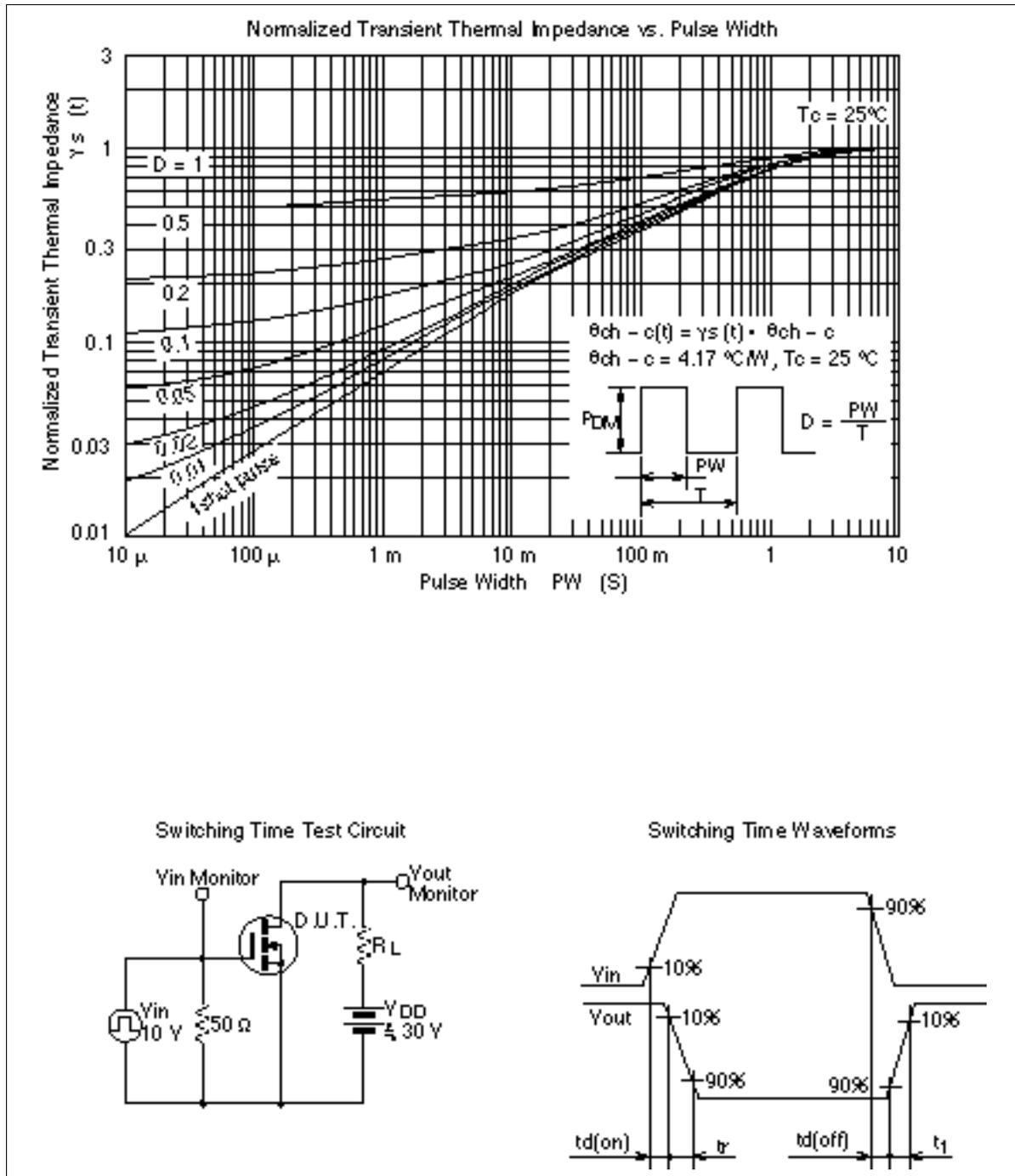
Avalanche Test Circuit



Avalanche Waveform

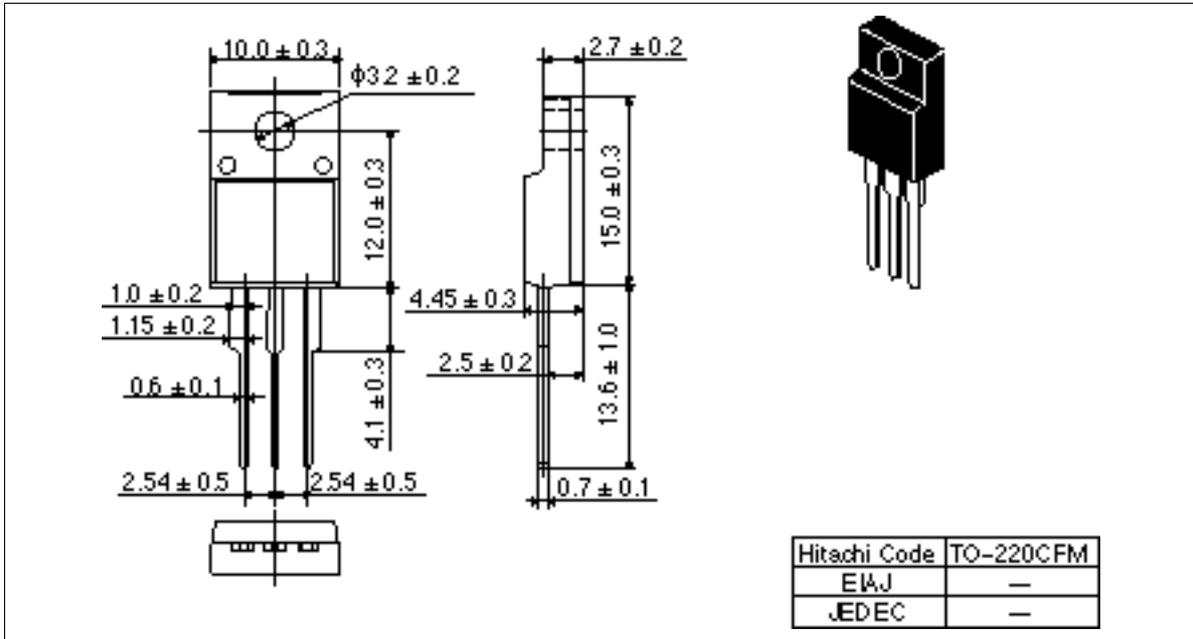
$$E_{AR} = \frac{1}{2} \cdot L \cdot I_{AP}^2 \cdot \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$





Package Dimensions

Unit: mm



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